



DSIAC TECHNICAL INQUIRY (TI) RESPONSE REPORT

Using Shape Memory Alloys as an Intermediate for Materials with Dissimilar Coefficients of Thermal Expansion

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14. ABSTRACT

The Defense Systems Information Analysis Center received a technical inquiry on the topic of joining dissimilar materials. Historically, the integration of high-temperature materials used for leading edges, control surfaces, heat shields, etc. with metallic structural components has been challenging due to the brittle nature of the high-temperature materials and the difference in coefficients of thermal expansion from the more structural components. Information was requested about using the high strain recovery and temperature memory aspects of shape memory alloys (SMAs) to develop a coupling between these dissimilar materials. This coupling using SMAs might allow for controlled displacements and/or mitigated thermally induced stress at the integration points. The SMAs have potential as connection mechanisms between hot sections of a hypersonic vehicle and the cooler interior substructure. Materials engineering subject matter experts listed the efforts to produce these material systems (mostly sponsored by NASA) and identified several options in varying degrees of development and technology readiness levels.

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ABOUT DTIC AND DSIAC

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The Defense Systems Information Analysis Center (DSIAC) is a DoD IAC sponsored by DTIC to provide expertise in nine technical focus areas: weapons systems; survivability and vulnerability; reliability, maintainability, quality, supportability, and interoperability; advanced materials; military sensing; autonomous systems; energetics; directed energy; and non-lethal weapons. DSIAC is operated by SURVICE Engineering Company under contract FA8075-14-D-0001.

A chief service of the DoD IACs is free technical inquiry (TI) research, limited to 4 research hours per inquiry. This TI response report summarizes the research findings of one such inquiry jointly conducted by DSIAC.



ABSTRACT

The Defense Systems Information Analysis Center received a technical inquiry on the topic of joining dissimilar materials. Historically, the integration of high-temperature materials used for leading edges, control surfaces, heat shields, etc. with metallic structural components has been challenging due to the brittle nature of the high-temperature materials and the difference in coefficients of thermal expansion from the more structural components. Information was requested about using the high strain recovery and temperature memory aspects of shape memory alloys (SMAs) to develop a coupling between these dissimilar materials. This coupling using SMAs might allow for controlled displacements and/or mitigated thermally induced stress at the integration points. The SMAs have potential as connection mechanisms between hot sections of a hypersonic vehicle and the cooler interior substructure. Materials engineering subject matter experts listed the efforts to produce these material systems (mostly sponsored by NASA) and identified several options in varying degrees of development and technology readiness levels.



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1.0 TI Request

1.1 INQUIRY

Can the high strain recovery and temperature memory aspects of shape memory alloys (SMAs) make them useful for the development of a coupling between the dissimilar materials of the high-temperature materials used for leading edges, control surfaces, heat shields, etc., with metallic structural components that might allow for controlled displacements and/or mitigated thermally induced stress at the integration points?

1.2 DESCRIPTION

Achieving the desired capabilities of joining dissimilar materials would enable hypersonic vehicles with variable geometry to perform in-flight adaptation of aircraft aerodynamic surfaces in compliance with the most efficient shapes for each flight regime.

2.0 Tl Response

The Defense Systems Information Analysis Center (DSIAC) received support from subject matter experts (SMEs) in materials science and engineering from Texas Research Institute Austin (TRI Austin) and the University of North Texas. The SMEs used internal knowledge and performed a literature search using a combination of open sources, the Defense Technical Information Center, and university library resources to respond to the technical inquiry.

2.1 FAILURE MECHANISMS FOR SMAs REQUIRED FOR COUPLING DISSIMILAR MATERIALS

The primary anticipated failure mechanisms that might be exhibited are residual stresses and fatigue stresses associated with heating events generating irrecoverable strain (depending on the requirements of the craft. See an example in Figure 1.).



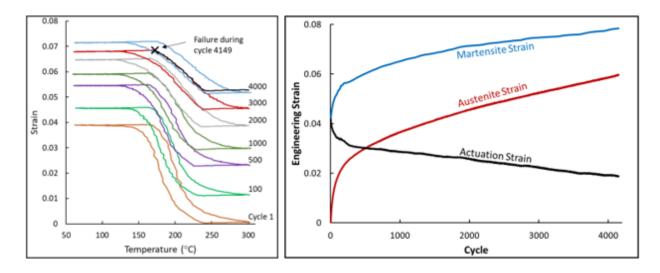


Figure 1: Irrecoverable Strain as a Result of Cycling – Increasing the Number of Cycles Causes a Decrease in the Amount of Irrecoverable Strain (Visualized as the Distance of the Strain vs. Temperature Hysteresis Curve, left) and Evolution of the Strain in the Material as a Function of Exposed Actuation Cycles (right)

(Source: N. A. Ley et al. [1]).

The National Aeronautics and Space Administration (NASA) has researched the use of SMAs as actuators of various sorts for high-speed aircraft. Examples are shown on NASA's website [2, 3]. In addition, a DSIAC webinar recently (29 April 2020) covered a wide range of SMA actuation topics [4].

In 2010, Akselsen published work on the joining of shape memory alloys [5]. In this research, ductile metal interlayers were required for joining nickel titanium (NiTi) alloys, and with an optimum bonding procedure, the shape recovery reached a total of 91% of the base metal. The author notes that welding SMAs is possible but produces brittle joints due to the formation of intermetallic compounds in the microstructure. The author also mentions the possibility of using additives to prevent or mitigate the formation of intermetallics but explains that very little related information is available. Brazing was studied, but again, the formation of intermetallics was a problem. A proper ductile interlayer is suggested to prevent excessive diffusion and to accommodate thermal strains associated with the mismatch in coefficients of thermal expansion (CTEs), which is precisely the problem that is sought to be avoided.

A patent from Shaw and Grummon in 2013 discusses the use of pure niobium as a transient liquid reactive braze material to fabricate cellular/honeycomb structures using Nitinol by flowing into capillary spaces between elements to be joined, creating a strong joint [6]. The authors do not mention niobium's ability to resist strong CTE mismatches.

Oliveira et al. (2017) discuss dissimilar laser welding of superelastic NiTi and copper aluminum manganese (CuAlMn) SMAs and state specifically that if the materials joined have significantly different CTEs, the joint may fail during solidification due to residual stresses [7]. The authors did note that the superelastic properties of the joint were preserved, although an irrecoverable



strain of \sim 2% was observed due to the unfavorable microstructure (columnar to equiaxed dendritic grain growth in the majority of the joint) in the fusion zone.

Older work from 1989 by D. Stoeckel of the Raychem Corporation, which went defunct in 1999, discusses the use of SMA springs in a governor valve as a means of temperature compensation, which may provide a path forward for the inquirer, depending on the specific means that the joining of the different structural pieces are connected to the metallic substructure [8]. In addition, the work also describes SMA washers that can be used when high forces and small motions are required (specifically, such as to compensate for different thermal expansions of dissimilar materials). The author also discusses gearboxes with steel shafts and aluminum cases in which rattling noise is caused by a decrease in the preload of the assembly with increasing temperature. Ni-Ti Belleville-type or wave washers can generate greater than 1 kN with a deflection of ~0.5 mm and restore the preload to the gearbox upon reaching its operating temperature (Figure 2). The author notes that this configuration is used by Toyota of Japan in their Sprinter/Carib cars.

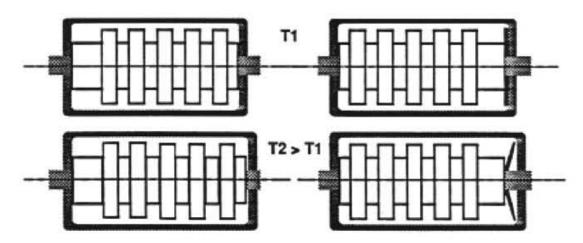


Figure 2: Schematic Showing Compensation for Thermal Expansion of Dissimilar Metals in a Gearbox for Toyota's Sprinter/Carib Cars (Source: Stoeckel 1989 [8]).

There appear to be options to potentially engineer SMAs to act as connection pieces between hot components of a hypersonic vehicle and the cool substructure. However, the temperature that the SMAs will reach is still unknown. For an SMA to be an effective, flexible joint between the different parts of the structure, it must have an appropriate temperature range and retain its desirable properties within that range, otherwise, its effect will be nullified. Transformation ranges for a number of different alloy types are shown in Table 1. Note that Table 1 is not a complete list of SMAs and their properties.



Table 1: Transformation Temperature Ranges for SMAs (Source: Swardz [9])

Alloy	Composition Atomic (at.) or Weight (wt.) %	Transformation Temperature Range (°C)
Ag - Cd	44-49 at.%	-190 to -50
Au - Cd	46.5-50 at.%	30 to 100
Cu - Al - Ni	14-14.5 wt.% / 3-4.5 wt.%	-140 to 100
Cu - Sn	approx. 15 at. %	-120 to 30
Cu - Zn	38.5-41.5 wt. %	-180 to -10
Cu - Zn - (Si,Sn,Al)	a few wt.% of (Si, Sn, Al)	-180 to 200
In - Ti	18-23 at. %	60 to 100
Ni - Al	36-38 at. %	-180 to 100
Ni - Ti	49-51 at. %	-50 to 110
Fe - Pt	~ 25 at. % Pt	approx130
Mn - Cu	5–35 at. % Cu	-250 to 180

Ag=silverFe=ironSi=siliconAl=aluminumMn=manganeseSn=tinAu=goldNi=nickelTi=titaniumCu=copperPt=platinumZn=zinc



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Richard Piner currently serves in the Mechanical Engineering Department at the University of Texas at Austin. He has over 48 years of industry experience spanning a wide variety of technical topics, including, but not limited to, the four broad categories of reactors, graphene, graphene oxide, and scanning technique. He has hundreds of scholarly publications yielding over 40,000 citations to his work. Dr. Piner holds a Ph.D. in physics from Purdue, where he studied scanning tunneling microscopy.

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